

GBU10005 THRU GBU1010

SINGLE PHASE10.0AMPS.GLASS PASSIVATED BRIDGE RECTIFIERS

FEATURE

. UL Listed Under Recognized Component Index, File Number E338195

- . Glass passivated chip junctions
- . High case dielectric stength
- . Low Reverse Leakage Current
- . High surge current capability
- . Ideal for Printed Circuit Board Applications

MECHANICAL DATA

. Case: GBU

. Case Material: Molded Plastic.

UL Flammability Classification Rating 94V-0

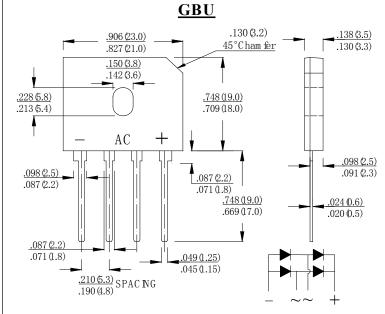
. Terminals: Pure tin plated, Lead free.

Leads solderable per MIL-STD-750, Method 2026.

. Polarity: Molded on Body

Mounting: Through Hole for #6 Screw
Mounting Torque: 5.0 in-lbs Maximum

. Weight: 3.8 grams



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number	SYM BOL	GBU 10005	GBU 1001	GBU 1002	GBU 1004	GBU 1006	GBU 1008	GBU 1010	units
Maximum Recurrent Peak Reverse Voltage	$V_{ m RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	$V_{ m RMS}$	35	70	140	280	420	560	700	V
Maximum DC blocking Voltage	$V_{ m DC}$	50	100	200	400	600	800	1000	V
Maximum Average Forward (with heatsink Note2) ,	10.0 3.0							A
Rectified Current @ T _C =100°C(without heatsink)	$I_{\text{F(AV)}}$								
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rate load (JEDEC method)	$I_{ m FSM}$				220				A
Maximum Forward Voltage @ 10.0A DC Drop per element @ 5.0A DC	$V_{ m F}$	1.1 1.0							V
Maximum DC Reverse Current $@T_J = 25^{\circ}C$ at rated DC blocking voltage $@T_J = 125^{\circ}C$	$I_{ m R}$	5.0 500.0							μΑ
I ² t Rating for Fusing (t < 8.3ms)	<i>I</i> ² t	200						A ² Sec	
Typical Junction Capacitance (Note 1)	C _J	70							pF
Typical Thermal Resistance (Note 2)	$R_{(JC)}$	2.0						°C/W	
Storage Temperature	T _{STG}	-55 to +150						°C	
Operating Junction Temperature	$T_{ m J}$			-5	5 to +15	0			°C

Note:

- 1. Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc
- 2.Device mounted on 150mm x 150mm x 1.6mm Cu Plate Heatsink.

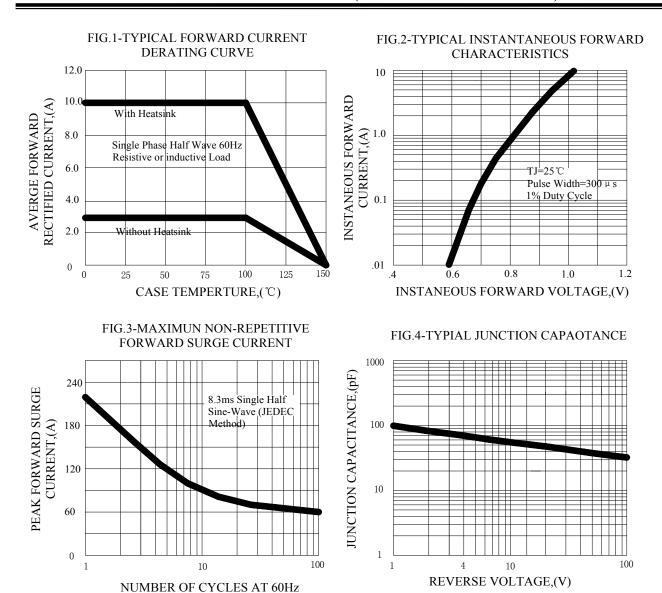
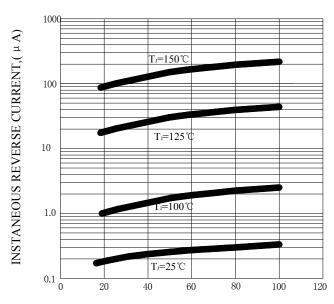


FIG.5-TYPICAL REVERSE CHARACTERISTICS



PERCENT OF RATED PEAK REVERSE VOLTAGE,(%)